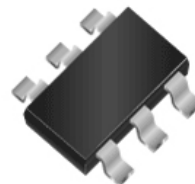


# WPM2037

## Single P-Channel, -20V, -3.6A , Power MOSFET

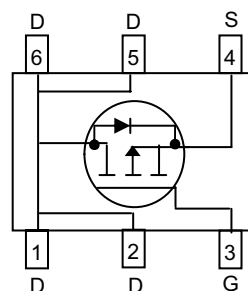
V <sub>DS</sub> (V)	R <sub>ds(on)</sub> (Ω)
-20	0.047@ V <sub>GS</sub> = - 4.5V
	0.060@ V <sub>GS</sub> = - 2.5V
	0.076@ V <sub>GS</sub> = - 1.8V



SOT-23-6L

### Descriptions

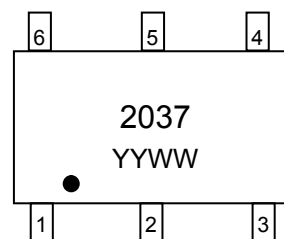
The WPM2037 is P-Channel enhancement MOS Field Effect Transistor. Uses advanced trench technology and design to provide excellent R<sub>DS (ON)</sub> with low gate charge. This device is suitable for use in DC-DC conversion, power switch and charging circuit. Standard Product WPM2037 is Pb-free.



### Features

- Trench Technology
- Supper high density cell design
- Excellent ON resistance for higher DC current
- Extremely Low Threshold Voltage
- Small package SOT-23-6L

### Pin configuration (Top view)



2037 = Device Code  
 YY = Year  
 WW = Week

### Applications

- Driver for Relay, Solenoid, Motor, LED etc.
- DC-DC converter circuit
- Power Switch
- Load Switch
- Charging

### Marking

### Order information

Device	Package	Shipping
WPM2037-6/TR	SOT-23-6L	3000/Reel&Tape

**Absolute Maximum ratings**

Parameter		Symbol	10 S	Steady State	Unit
Drain-Source Voltage		$V_{DS}$	-20		V
Gate-Source Voltage		$V_{GS}$	$\pm 12$		
Continuous Drain Current <sup>a</sup>	$T_A=25^\circ\text{C}$	$I_D$	-3.6	-3.3	A
	$T_A=70^\circ\text{C}$		-2.9	-2.7	
Maximum Power Dissipation <sup>a</sup>	$T_A=25^\circ\text{C}$	$P_D$	1.1	0.9	W
	$T_A=70^\circ\text{C}$		0.7	0.6	
Continuous Drain Current <sup>b</sup>	$T_A=25^\circ\text{C}$	$I_D$	-3.3	-3.1	A
	$T_A=70^\circ\text{C}$		-2.7	-2.4	
Maximum Power Dissipation <sup>b</sup>	$T_A=25^\circ\text{C}$	$P_D$	0.9	0.8	W
	$T_A=70^\circ\text{C}$		0.6	0.5	
Pulsed Drain Current <sup>c</sup>		$I_{DM}$	-20		A
Operating Junction Temperature		$T_J$	150		$^\circ\text{C}$
Lead Temperature		$T_L$	260		$^\circ\text{C}$
Storage Temperature Range		$T_{stg}$	-55 to 150		$^\circ\text{C}$

**Thermal resistance ratings**

Parameter		Symbol	Typical	Maximum	Unit
Junction-to-Ambient Thermal Resistance <sup>a</sup>	$t \leq 10 \text{ s}$	$R_{\theta JA}$	90	108	$^\circ\text{C/W}$
	Steady State		112	128	
Junction-to-Ambient Thermal Resistance <sup>b</sup>	$t \leq 10 \text{ s}$	$R_{\theta JA}$	110	128	
	Steady State		132	152	
Junction-to-Case Thermal Resistance		$R_{\theta JC}$	50	68	

a Surface mounted on FR4 Board using 1 square inch pad size, 1oz copper

b Surface mounted on FR4 board using minimum pad size, 1oz copper

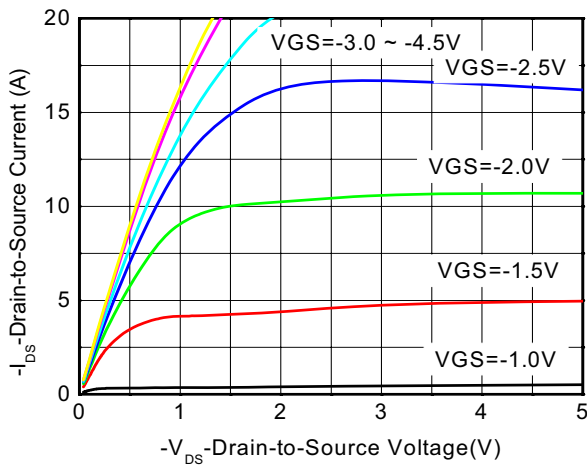
c Repetitive rating, pulse width limited by junction temperature,  $t_p=10\mu\text{s}$ , Duty Cycle=1%

d Repetitive rating, pulse width limited by junction temperature  $T_J=150^\circ\text{C}$ .

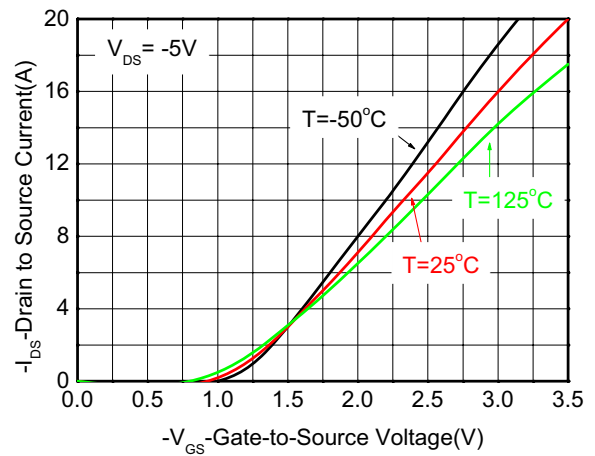
**Electronics Characteristics (Ta=25°C, unless otherwise noted)**

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
<b>OFF CHARACTERISTICS</b>						
Drain-to-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS} = 0\text{ V}, I_D = -250\mu\text{A}$	-20			V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = -16\text{ V}, V_{GS} = 0\text{ V}$			-1	$\mu\text{A}$
Gate-to-source Leakage Current	$I_{GSS}$	$V_{DS} = 0\text{ V}, V_{GS} = \pm 12\text{ V}$			$\pm 100$	nA
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{GS} = V_{DS}, I_D = -250\mu\text{A}$	-0.35	-0.58	-1.0	V
Drain-to-source On-resistance	$R_{DS(on)}$	$V_{GS} = -4.5\text{ V}, I_D = -3.2\text{ A}$		47	61	m $\Omega$
		$V_{GS} = -2.5\text{ V}, I_D = -2.8\text{ A}$		59	71	
		$V_{GS} = -1.8\text{ V}, I_D = -2.3\text{ A}$		77	94	
Forward Transconductance	$g_{FS}$	$V_{DS} = -5.0\text{ V}, I_D = -3.6\text{ A}$		10		S
<b>CHARGES, CAPACITANCES AND GATE RESISTANCE</b>						
Input Capacitance	$C_{ISS}$	$V_{GS} = 0\text{ V}, f = 1.0\text{ MHz}, V_{DS} = -10\text{ V}$		1130		pF
Output Capacitance	$C_{OSS}$			120		
Reverse Transfer Capacitance	$C_{RSS}$			115		
Total Gate Charge	$Q_{G(TOT)}$	$V_{GS} = -4.5\text{ V}, V_{DS} = -10\text{ V}, I_D = -2.7\text{ A}$		11		nC
Threshold Gate Charge	$Q_{G(TH)}$			0.6		
Gate-to-Source Charge	$Q_{GS}$			1.3		
Gate-to-Drain Charge	$Q_{GD}$			2.7		
<b>SWITCHING CHARACTERISTICS</b>						
Turn-On Delay Time	$t_d(ON)$	$V_{GS} = -4.5\text{ V}, V_{DS} = -6\text{ V}, R_L = 3\ \Omega, R_G = 6\ \Omega$		9.5		ns
Rise Time	$t_r$			5.8		
Turn-Off Delay Time	$t_d(OFF)$			54		
Fall Time	$t_f$			13		
<b>BODY DIODE CHARACTERISTICS</b>						
Forward Voltage	$V_{SD}$	$V_{GS} = 0\text{ V}, I_S = -1.0\text{ A}$		-0.75	-1.5	V

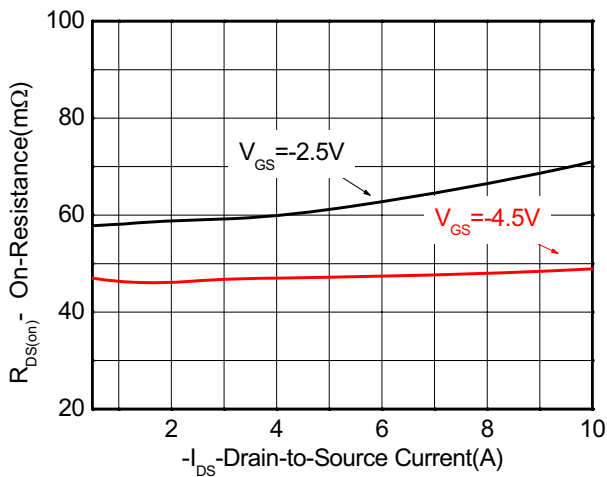
Typical Characteristics (Ta=25°C, unless otherwise noted)



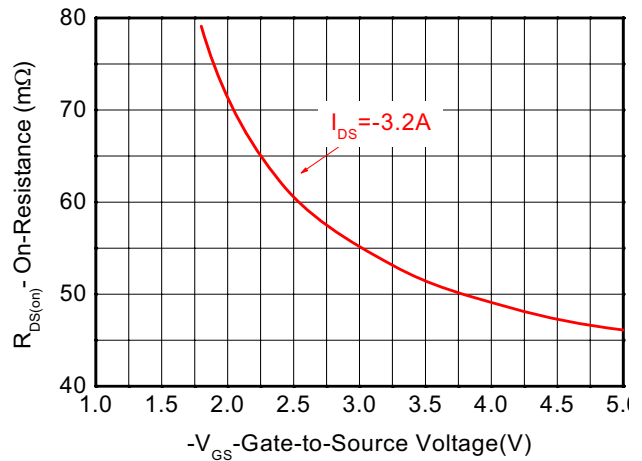
Output characteristics



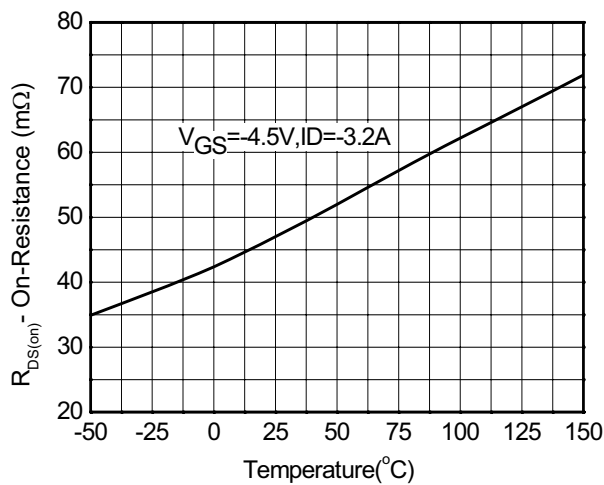
Transfer characteristics



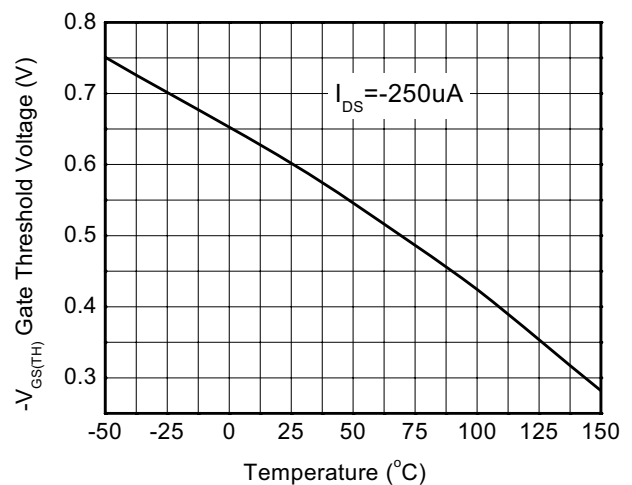
On-Resistance vs. Drain current



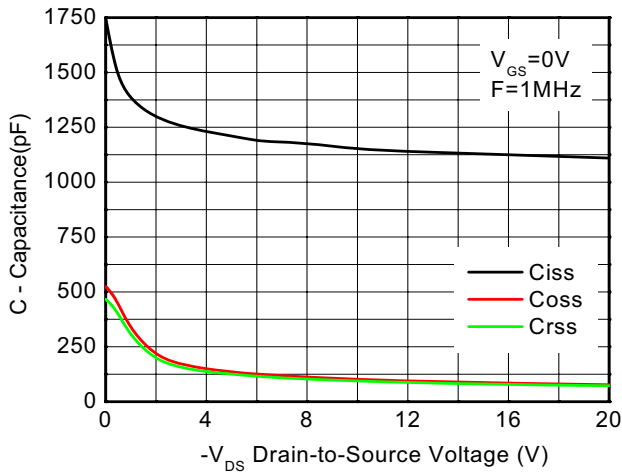
On-Resistance vs. Gate-to-Source voltage



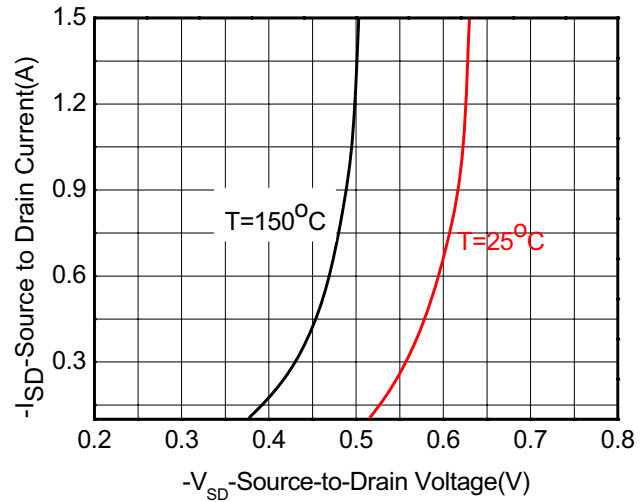
On-Resistance vs. Junction temperature



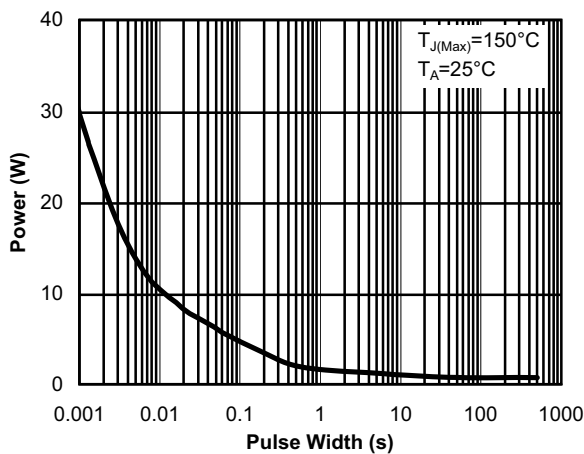
Threshold voltage vs. Temperature



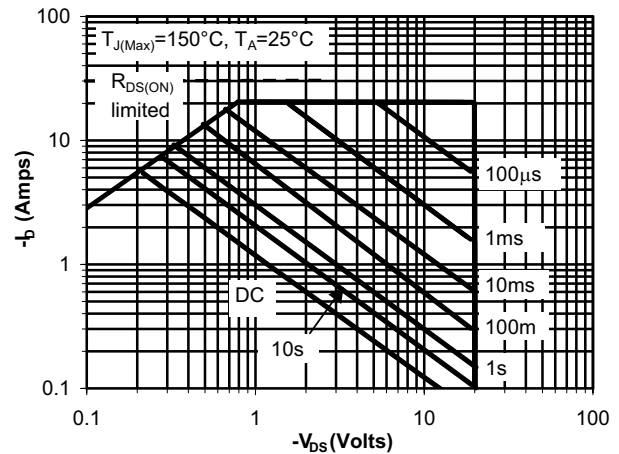
Capacitance



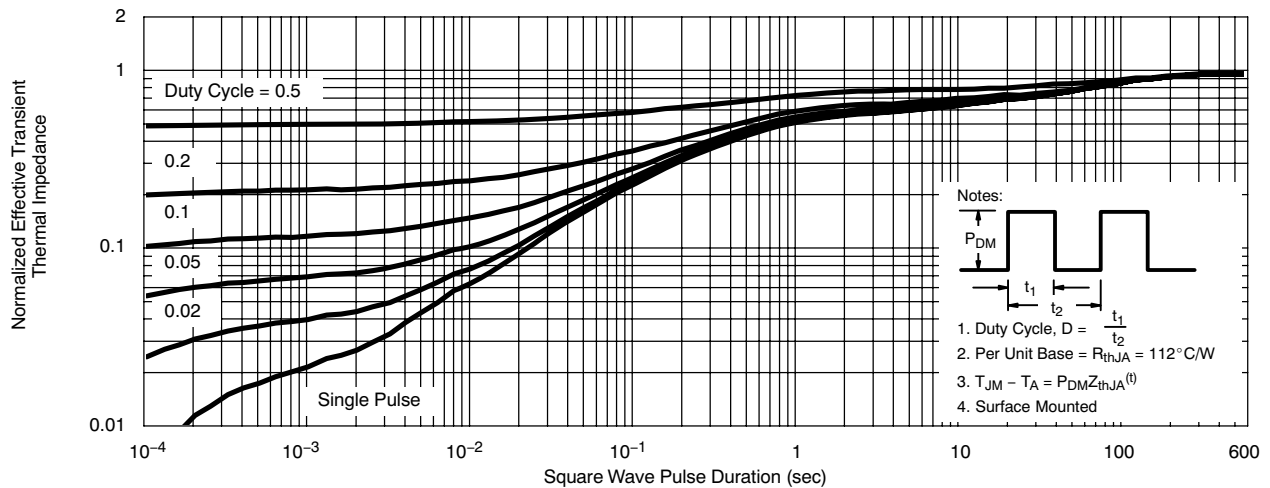
Body diode forward voltage



Single pulse power



Safe operating area

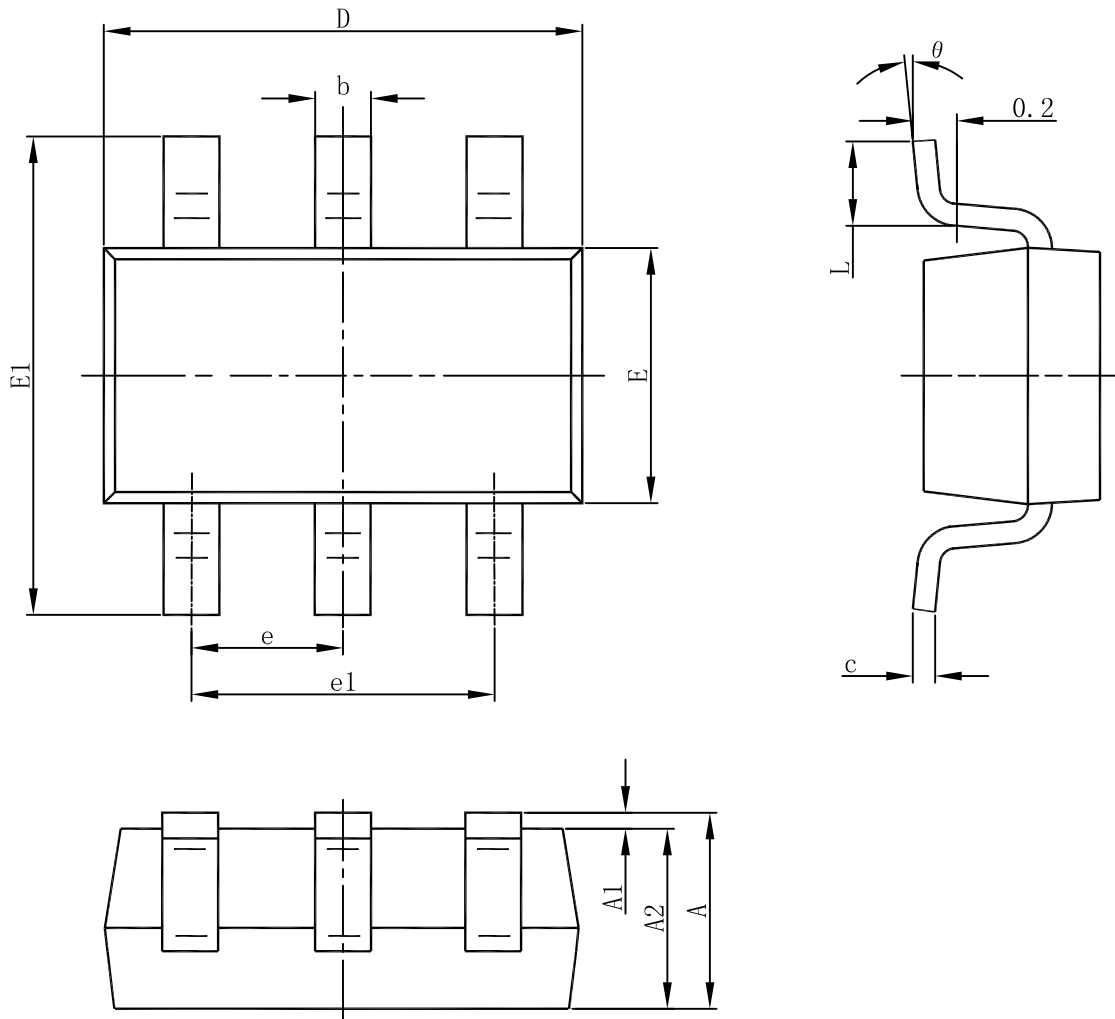


Transient thermal response (Junction-to-Ambient)

Package outline dimensions

WPM2037

SOT-23-6L



Symbol	Dimensions in millimeter		
	Min.	Typ.	Max.
A	1.050	1.150	1.250
A1	0.000	0.050	0.100
A2	1.050	1.100	1.150
b	0.300	0.400	0.500
c	0.100	0.150	0.200
D	2.820	2.920	3.020
E	1.500	1.600	1.700
E1	2.650	2.800	2.950
e	0.950(BSC)		
e1	1.800	1.900	2.000
L	0.300		0.600
θ	0°		8°